1-178138-3 ACTIVE

Dynamic Series | Dynamic 3000 Series

TE Internal #: 1-178138-3

PCB Mount Header, Horizontal, Wire-to-Board, 3 Position, 5.08 mm [.2 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder,

Dynamic 3000 Series

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > Header Assembly: Wire-to-Board, 15A, gold or tin plated

Connector System: Wire-to-Board

Number of Positions: 3
Number of Rows: 1

Centerline (Pitch): 5.08 mm [.2 in]
PCB Mount Orientation: Horizontal

All Header Assembly: Wire-to-Board, 15A, gold or tin plated (134)

Features

Product Type Features

Connector System	Wire-to-Board	
Header Type	Fully Shrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
PCB Connector Assembly Type	PCB Mount Header	
Configuration Features		

Number of Positions	3
Number of Rows	1
PCB Mount Orientation	Horizontal

Body Features

Contact Features

Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
Contact Mating Area Plating Material	Gold
Contact Type	Pin
Contact Current Rating (Max)	12 A

Termination Features

Termination Method to Printed Circuit Board Through Hole - Solder	Termination Method to Printed Circuit Board	Through Hole - Solder
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Mechanical Attachment

Mating Alignment Type	Keyed	
Mating Retention	With	
PCB Mount Retention Type	Retention Leg	
Connector Mounting Type	Board Mount	
Mating Alignment	With	
PCB Mount Alignment	Without	
PCB Mount Retention	With	
Housing Features		
Housing Material	Polyester GF	
Centerline (Pitch)	5.08 mm[.2 in]	
Usage Conditions		
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]	
Operation/Application		
Circuit Application	Power & Signal	
	Power & Signal	

Packaging Features

Packaging Type	Box, Tube	

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

PCB Mount Header, Horizontal, Wire-to-Board, 3 Position, 5.08 mm [.2 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 3000 Series



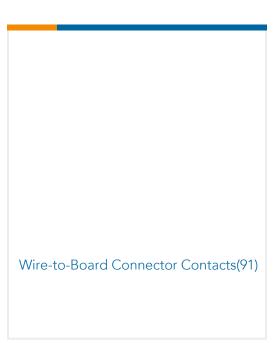
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts TE Part # 1-178128-3 DYNAMIC 3200 REC HSG 3P SGL

Also in the Series	Dynamic 3000 Series		
Connector Contacts(3)	Insertion & Extraction Tools(1)	PCB Connector Keying(1)	PCB Connector Mounting(8)
PCB Headers & Receptacles(283)	PCB Terminal Blocks(25)	Standard Rectangular Connectors(2)	Wire-to-Board Connector Assemblies & Housings(152)





Customers Also Bought

TE Part #178325-3 Header Assembly: Wire-to-Board, 15A, gold or tin plated

TE Part #1-2347004-5 Header Assembly: Wire-to-Board Connector, Spring Clamp, 5.08 mm pitch, 10A

TE Part #2347681-1 OPENER, D2950

Documents

Product Drawings

DYNAMIC 3200 HDR H 3P ASSY

English

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_1-178138-3_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_1-178138-3_E.3d_igs.zip

English

Customer View Model

ENG_CVM_1-178138-3_E.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

Japanese

1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

English

Product Specifications

Product Specification

PCB Mount Header, Horizontal, Wire-to-Board, 3 Position, 5.08 mm [.2 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 3000 Series



English

Product Environmental Compliance

MD_1-178138-3_08032012940

English

MD_1-178138-3_08032012940

English

Agency Approvals

Agency Approval Document

English